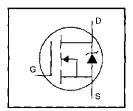
International Rectifier

HEXEET® Power MOSEET

- Isolated Package
- High Voltage Isolation= 2.5KVRMS ®
- Sink to Lead Creepage Dist.= 4.8mm
- Dynamic dv/dt Rating
- Low Thermal Resistance

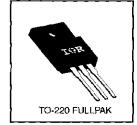


$$\begin{cases} V_{DSS} = 450V \\ R_{DS(on)} = 0.63\Omega \end{cases}$$
$$I_{D} = 4.9A$$

Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 Fullpak eliminates the need for additional insulating hardware in commercial-industrial applications. The moulding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The Fullpak is mounted to a heatsink using a single clip or by a single screw fixing.



Absolute Maximum Ratings

	Parameter	Max.	Units	
Ip @ Tc = 25°C	Continuous Drain Current, VGS @ 10 V	4.9		
In @ Tc = 100°C	Continuous Drain Current, VGS @ 10 V	3.1	A	
low	Pulsed Drain Current ①	20	_]	
Po @ Tc = 25°C	Power Dissipation	40	W	
	Linear Derating Factor	0.32	W/°C	
V _G s	Gate-to-Source Voltage	±20	٧	
Eas	Single Pulse Avalanche Energy ②	130	mJ	
IAR	Avaianche Current ①	4.9	A	
Ear	Repetitive Avalanche Energy ①	4.0	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	3.5	V/ns	
TJ	Operating Junction and	-55 to +150		
Tsra	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	i	
	Mounting Torque, 6-32 or M3 screw	10 lbf-in (1.1 N-m)	ĺ	

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
Rexc	Junction-to-Case		ļ <u></u>	3.1	°C/W
Raja	Junction-to-Ambient	<u> </u>	L	65	



Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	450			' V	V _{GS} =0V, I _D = 250μA
ΔV _{(BR)DSS} /ΔT	J Breakdown Voltage Temp. Coefficient	i —	0.59	_	: V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		_	0.63	Ω	V _{GS} =10V, I _D =2.9A ④
V _{GS(th)}	Gate Threshold Voltage	2.0	<u> </u>	4.0	٧	V _{DS} =V _{GS} , I _D = 250μA
g _{fs}	Forward Transconductance	3.3		_	S	V _{DS} =50V, I _D =2.9A ④
pss	Drain-to-Source Leakage Current			25	μA i	V _{DS} =450V, V _{GS} =0V
	Stair to Coulce Leakage Current	<u> </u>		250	ι μΑ	V _{DS} =360V, V _{GS} =0V, T _J =125°C
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	V _{GS} =20V
	Gate-to-Source Reverse Leakage	_	<u></u> _	-100	II/A.	V _{GS} =-20V
Q_g	Total Gate Charge	<u></u>		80		I _D =8.8A
Q_{gs}	Gate-to-Source Charge	<u> </u>	<u> </u>	12	nC	V _{DS} =360V
Q_{gd}	Gate-to-Drain ("Miller") Charge		<u>L — , </u>	41		V _{GS} =10V See Fig. 6 and 13 €
t _{d(on)}	Turn-On Delay Time	_	8.7			V _{DD} =225V
tr	Rise Time		28		ns	I _D =8.8A
t _{d(off)}	Turn-Off Delay Time	<u> </u>	58		110	R ₆ =9.1Ω
tf	Fall Time		27			R _D =25Ω See Figure 10 ⊛
L _D	Internal Drain Inductance	_	4.5	_	nH	Between lead, 6 mm (0.25in.)
Ls	Internal Source Inductance	_	7.5	_	ш	from package and center of die contact
Ciss	Input Capacitance	_	1400			V _{GS} =0V
Coss	Output Capacitance	_	370	_	pΕ	V _{DS} = 25V
Crss	Reverse Transfer Capacitance	<u> </u>	140	_		f=1.0MHz See Figure 5
С	Drain to Sink Capacitance		12		pF	f=1.0MHz

Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)			4.9		MOSFET symbol showing the
SM	Pulsed Source Current (Body Diode) ①		_	20	A	integral reverse
V _{SD}	Diode Forward Voltage	_	_	2.0	٧	TJ=25°C, Is=8.8A, VGS=0V @
trr	Reverse Recovery Time		490	740	ns	TJ=25°C, IF=8.8A
Qrr	Reverse Recovery Charge		3.2	4.8	μC	di/dt≃100A/μs ④
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+Lp)				

Notes:

- Repetitive rating; pulse width limited by max, junction temperature (See Figure 11)
- ③ I_{SD}≤8.8A, di/dt≤200A/μs, V_{DD}≤V_{(BR)D\$S}, T_J≤150°C
- ⑤ t=60s, f=60Hz

- V_{DD}=50V, starting T_J=25°C, L=9.6mH
 R_G=25Ω, I_{AS}=4.9A (See Figure 12)
- ⓐ Pulse width ≤ 300 μ s; duty cycle ≤2%.

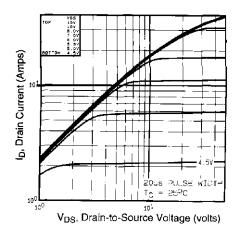


Fig 1. Typical Output Characteristics, T_C=25°C

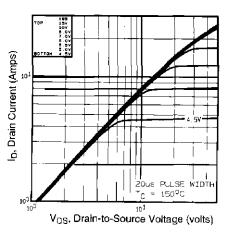


Fig 2. Typical Output Characteristics, Tc=150°C

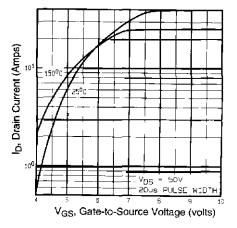


Fig 3. Typical Transfer Characteristics

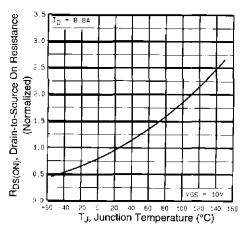


Fig 4. Normalized On-Resistance
Vs. Temperature

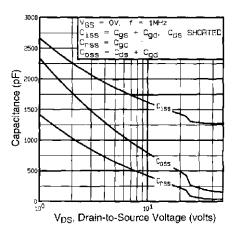


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

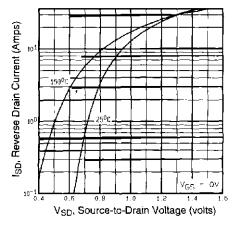


Fig 7. Typical Source-Drain Diode Forward Voltage

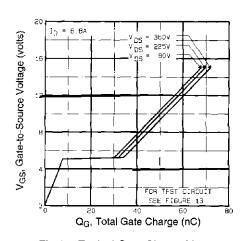


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

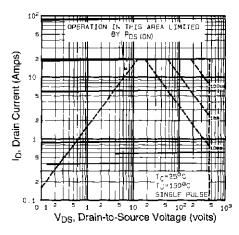


Fig 8. Maximum Safe Operating Area

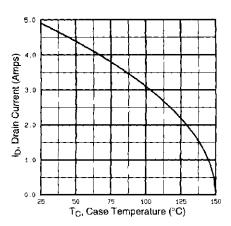


Fig 9. Maximum Drain Current Vs. Case Temperature

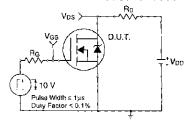


Fig 10a. Switching Time Test Circuit

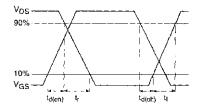


Fig 10b. Switching Time Waveforms

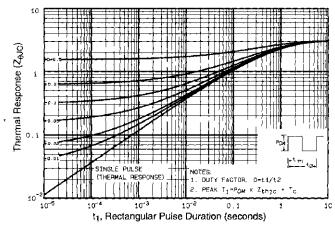


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

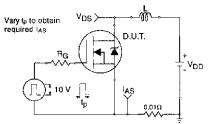


Fig 12a. Unclamped Inductive Test Circuit

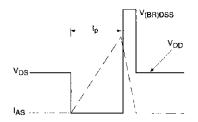


Fig 12b. Unclamped Inductive Waveforms

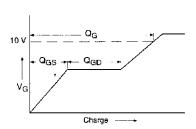


Fig 13a. Basic Gate Charge Waveform

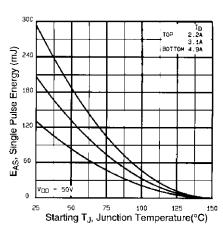


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

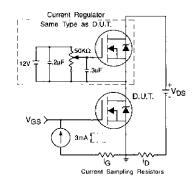


Fig 13b. Gate Charge Test Circuit

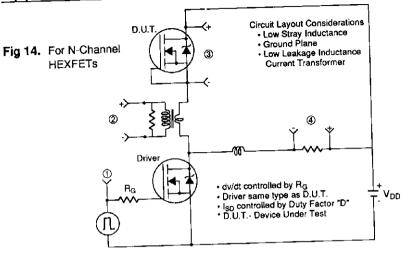
Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit

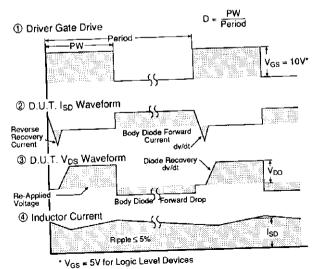
Appendix B: Package Outline Mechanical Drawing

Appendix C: Part Marking Information

Appendix A

Peak Diode Recovery dv/dt Test Circuit







Appendix B

* GATE

2 - DRAIN

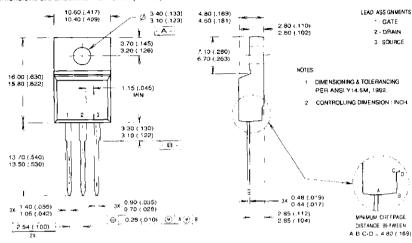
3 SOURCE

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Package Outline

TO-220 FullPak Outline

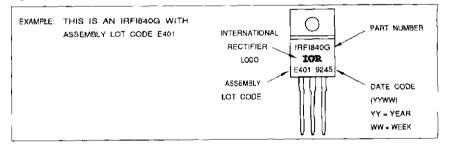
Dimensions are shown in millimeters (inches)



Part Marking Information

Appendix C

TO-220 FULL-PAK





Printed on Signet recycled offset: made from 50% recycled waste paper, including 10% de-inked, post-consumer waste.

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